

# **ESP-07 WiFi Module**

Version1.0

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# **Table Of Contents**

<b>1.</b> F	reamb	les	3
	1.1.	Features	4
	1.2.	Parameters	5
2.	Pin De	escriptions	6
3.	Packag	ging and Dimension	9
4.	Functi	onal Descriptions	10
	4.1.	MCU	10
	4.2.	Memory Organization	10
	4.2	2.1. Internal SRAM and ROM	10
	4.2	2.2. External SPI Flash	10
	4.3.	Crystal	11
	4.4.	Interfaces	12
	4.5.	Absolute Maximum Ratings	13
	4.6.	Recommended Operating Conditions	14
	4.7.	Digital Terminal Characteristics	14
5.	RF Per	formance	14
6.	Power	Consumption	15
7.	Reflov	v Profile	17
8.5	chema	tics	18

#### 1. Preambles

ESP-07 WiFi module is developed by Ai-thinker Team. core processor ESP8266 in smaller sizes of the module encapsulates Tensilica L106 integrates industry-leading ultra low power 32-bit MCU micro, with the 16-bit short mode, Clock speed support 80 MHz, 160 MHz, supports the RTOS, integrated Wi-Fi MAC/BB/RF/PA/LNA, on-board antenna.

The module supports standard IEEE802.11 b/g/n agreement, complete TCP/IP protocol stack. Users can use the add modules to an existing device networking, or building a separate network controller.

ESP8266 is high integration wireless SOCs, designed for space and power constrained mobile platform designers. It provides unsurpassed ability to embed Wi-Fi capabilities within other systems, or to function as a standalone application, with the lowest cost, and minimal space requirement.

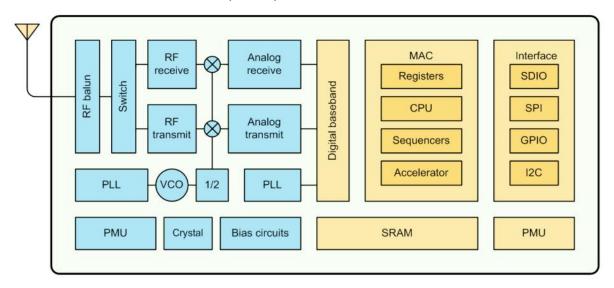


Figure 1 ESP8266EX Block Diagram

ESP8266EX offers a complete and self-contained Wi-Fi networking solution; it can be used to host the application or to offload Wi-Fi networking functions from another application processor.

When ESP8266EX hosts the application, it boots up directly from an external flash. In has integrated cache to improve the performance of the system in such applications.

Alternately, serving as a Wi-Fi adapter, wireless internet access can be added to any micro controllerbased design with simple connectivity (SPI/SDIO or I2C/UART interface).

ESP8266EX is among the most integrated WiFi chip in the industry; it integrates the antenna switches, RF balun, power amplifier, low noise receive amplifier, filters, power management modules, it requires minimal external circuitry, and the entire solution, including front-end module, is designed to occupy minimal PCB area.

ESP8266EX also integrates an enhanced version of Tensilica's L106 Diamond series 32-bit processor, with on-chip SRAM, besides the Wi-Fi functionalities. ESP8266EX is often integrated with external sensors and other application specific devices through its GPIOs; codes for such applications are provided in examples in the SDK.

Espressif Systems' Smart Connectivity Platform (ESCP) demonstrates sophisticated system-level features include fast sleep/wake context switching for energy-efficient VoIP, adaptive radio biasing. for low-power operation, advance signal processing, and spur cancellation and radio co-existence features for common cellular, Bluetooth, DDR, LVDS, LCD interference mitigation.

#### 1.1. Features

- 802.11 b/g/n
- Integrated low power 32-bit MCU
- Integrated 10-bit ADC
- Integrated TCP/IP protocol stack
- Integrated TR switch, balun, LNA, power amplifier and matching network
- Integrated PLL, regulators, and power management units
- Supports antenna diversity
- Wi-Fi 2.4 GHz, support WPA/WPA2
- Support STA/AP/STA+AP operation modes
- Support Smart Link Function for both Android and iOS devices
- SDIO 2.0, (H) SPI, UART, I2C, I2S, IRDA, PWM, GPIO
- STBC, 1x1 MIMO, 2x1 MIMO
- A-MPDU & A-MSDU aggregation and 0.4s guard interval
- Deep sleep power <10uA, Power down leakage current < 5uA</li>
- Wake up and transmit packets in < 2ms
- Standby power consumption of < 1.0mW (DTIM3)</li>

- +20dBm output power in 802.11b mode
- Operating temperature range -40C ~ 125C

## 1.2. Parameters

Table 1 below describes the major parameters.

Table 1 Parameters

Categories	Items	Values	
WiFi Paramters	WiFi Protocles	802.11 b/g/n	
	Frequency Range	2.4GHz-2.5GHz (2400M-2483.5M)	
		UART/HSPI/I2C/I2S/Ir Remote Contorl	
	Peripheral Bus	GPIO/PWM	
	Operating Voltage	3.0~3.6V	
Hardware	Operating Current	Average value: 80mA	
Paramaters	Operating Temperature Range	-40°~125°	
	Ambient Temperature Range	Normal temperature	
	Package Size	16mm*21.2mm*3mm	
	External Interface	N/A	
	Wi-Fi mode	station/softAP/SoftAP+station	
	Security	WPA/WPA2	
Software	Encryption	WEP/TKIP/AES	
Parameters	Firmware Upgrade	UART Download / OTA (via network) / download and write firmware via host	
	Ssoftware Development	Supports Cloud Server Development / SDK for custom firmware development	

Network Protocols	IPv4, TCP/UDP/HTTP/FTP
User Configuration	AT Instruction Set, Cloud Server, Android/iOS App

# 2. Pin Descriptions

There are altogether 16 pin counts, the definitions of which are described in Table 2 below.

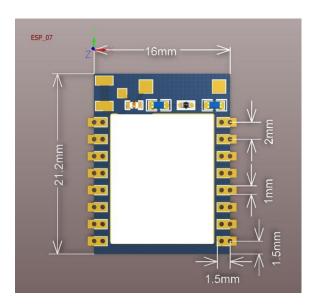


Table 2 Pin Design

**Table 3 Pin Descriptions** 

NO	Pin Name	Function
1	RST	Reset the module
2 ADC		A/D Conversion result.Input voltage range 0-1v,scope:0-1024

3	CH_PD	1)high level work 2) low leave power off
4	GPIO16	GPIO16; can be used to wake up the chipset from deep sleep mode
5	GPIO14	GPIO14; HSPI_CLK
6	GPIO12	GPIO12; HSPI_MISO
7	GPIO13	GPIO13; HSPI_MOSI; UARTO_CTS
8	VCC	3.3V power supply (VDD)
9	GND	GND
10	GPIO15	GPIO15; MTDO; HSPICS; UARTO_RTS
11	GPIO2	GPIO2; UART1_TXD
12	GPIO0	GPIO0
13	GPIO4	GPIO4
14	GPIO5	GPIO5
15	RXD0	UARTO_RXD; GPIO3
16	TXD0	UARTO_TXD; GPIO1

### **Table 4 Pin Mode**

Mode	GPIO15	GPIO0	GPIO2
UART	low	low	high
Flash Boot	low	high	high

# **Table 5 Receiver Sensitivity**

Parameters	Min	Typical	Max	Unit
Input frequency	2412		2484	MHz
Input impedance		50		Ω
Input reflection			-10	dB
Output power of PA for 72.2Mbps	14	15	16	dBm
Output power of PA for 11b mode	17.5	18.5	19.5	dBm
Sensitivity				
DSSS, 1 Mbps		-98		dBm
CCK, 11 Mbps		-91		dBm
6 Mbps (1/2 BPSK)		-93		dBm
54 Mbps (3/4 64-QAM)		-75		dBm
HT20, MCS7 (65 Mbps, 72.2 Mbps)		-72		dBm
Adja	cent Channel	Rejection		
OFDM, 6 Mbps		37		dB
OFDM, 54 Mbps		21		dB
HT20, MCS0		37		dB
HT20, MCS7		20		dB

# 3. Packaging and Dimension

The external size of the module is 16mm\*21.2mm\*3mm, as is illustrated in Figure 3 below. The type of flash integrated in this module is an SPI flash, the capacity of which is 1 MB, and the package size of which is SOP-210mil. The antenna applied on this module is a ceramic antenna.



Figure 2 [Module Pin Counts, 16 pin, 16.0 mm x 21.2 mm x 3.0 mm]

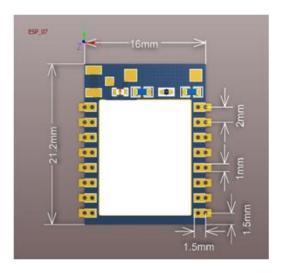


Figure 3 Top View of ESP-07 WiFi Module

#### Table 6 Dimension of ESP-07 WiFi Module

Length	Width	Height	PAD Size(Bottom)	Pin Pitch
16mm	21.2mm	3 mm	0.9 mm x 1.7 mm	2mm

## 4. Functional Descriptions

#### **4.1.** MCU

ESP8266EX is embedded with Tensilica L106 32-bit micro controller (MCU), which features extra low power consumption and 16-bit RSIC. The CPU clock speed is 80MHz. It can also reach a maximum value of 160MHz. ESP8266EX is often integrated with external sensors and other specific devices through its GPIOs; codes for such applications are provided in examples in the SDK.

### 4.2. Memory Organization

#### 4.2.1. Internal SRAM and ROM

ESP8266EX WiFi SoC is embedded with memory controller, including SRAM and ROM. MCU can visit the memory units through iBus, dBus, and AHB interfaces. All memory units can be visited upon request, while a memory arbiter will decide the running sequence according to the time when these requests are received by the processor.

According to our current version of SDK provided, SRAM space that is available to users is assigned as below:

- •RAM size < 36kB, that is to say, when ESP8266EX is working under the station mode and is connected to the router, programmable space accessible to user in heap and data section is around 36kB.)
- There is no programmable ROM in the SoC, therefore, user program must be stored in an external SPI flash.

#### 4.2.2. External SPI Flash

This module is mounted with an 1 MB external SPI flash to store user programs. If larger definable storage space is required, a SPI flash with larger memory size is preferred. Theoretically speaking, up to 16 MB memory capacity can be supported.

#### Suggested SPI Flash memory capacity:

- •OTA is disabled: the minimum flash memory that can be supported is 512 kB;
- •OTA is enabled: the minimum flash memory that can be supported is 1 MB.

Several SPI modes can be supported, including Standard SPI, Dual SPI, and Quad SPI.

Therefore, please choose the correct SPI mode when you are downloading into the flash, otherwise firmwares/programs that you downloaded may not work in the right way.

### 4.3. Crystal

Currently, the frequency of crystal oscillators supported include 40MHz, 26MHz and 24MHz. The accuracy of crystal oscillators applied should be ±10PPM, and the operating temperature range should be between -20°C and 85°C.

When using the downloading tools, please remember to select the right crystal oscillator type. In circuit design, capacitors C1 and C2, which are connected to the earth, are added to the input and output terminals of the crystal oscillator respectively. The values of the two capacitors can be flexible, ranging from 6pF to 22pF, however, the specific capacitive values of C1 and C2 depend on further testing and adjustment on the overall performance of the whole circuit. Normally, the capacitive values of C1 and C2 are within 10pF if the crystal oscillator frequency is 26MHz, while the values of C1 and C2 are 10pF<C1, C2<22pF if the crystal oscillator frequency is 40MHz.

## 4.4. Interfaces

**Table 7 Descriptions of Interfaces** 

Interface	Pin Name	Description
HSPI	IO12(MISO), IO13(MOSI) IO14(CLK), IO15(CS)	SPI Flash , display screen, and MCU can be connected using HSPI interface
PWM	IO12(R), IO15(G), IO13(B)	Currently the PWM interface has four channels, but users can extend the channels according to their own needs. PWM interface can be used to control LED lights, buzzers, relays, electronic machines, and so on.
IR Remote Control	IO14(IR_T) <i>,</i> IO5(IR_R)	The functionality of Infrared remote control interface can be implemented via software programming. NEC coding, modulation, and demodulation are used by this interface. The frequency of modulated carrier signal is 38KHz.
ADC	тоит	ESP8266EX integrates a 10-bit analog ADC. It can be used to test the power supply voltage of VDD3P3 (Pin3 and Pin4) and the input power voltage of TOUT (Pin 6). However, these two functions cannot be used simultaneously. This interface is typically used in sensor products.
I2C	IO14(SCL), IO2(SDA)	I2C interface can be used to connect external sensor products and display screens, etc.
UARTO: TXD(U0TXD), RXD(U0RXD), UART IO15(RTS), IO13(CTS) UART1: IO2(TXD)		Devices with UART interfaces can be connected with the module.  Downloading: U0TXD+U0RXD or GPIO2+U0RXD  Communicating: UARTO: U0TXD, U0RXD, MTDO (U0RTS), MTCK  (U0CTS)  Debugging: UART1_TXD (GPIO2) can be used to print debugging information.  By default, UARTO will output some printed information when the device is powered on and is booting up. If this issue exerts influence on some specific applications, users can exchange the inner pins of UART when initializing, that is to say, exchange U0TXD, U0RXD with

		UORTS, UOCTS.
	I2S Input:	
	IO12 (I2SI_DATA) ;	
	IO13 (I2SI_BCK );	
	IO14 (I2SI_WS);	
125	I2S Output: :	I2S interface is mainly used for collecting, processing, and transmission of audio data.
	IO15 (I2SO_BCK );	
	IO3 (I2SO_DATA);	
	IO2 (I2SO_WS ).	

# 4.5. Absolute Maximum Ratings

# **Table 8 Absolute Maximum Ratings**

Rating	Condition	Value	Unit
Storage Temperature		-40 to 125	°C
Maximum Soldering Temperature		260	°C
Supply Voltage	IPC/JEDEC J-STD-020	+3.0 to +3.6	V

# 4.6. Recommended Operating Conditions

**Table 9 Recommended Operating Conditions** 

Operating Condition	Symbol	Min	Тур	Max	Unit
Operating Temperature		-40	20	125	℃
Supply voltage	VDD	3.0	3.3	3.6	V

# 4.7. Digital Terminal Characteristics

**Table 10 Digital Terminal Characteristics** 

Terminals	Symbol	Min	Тур	Max	Unit
Input logic level low	VIL	-0.3		0.25VDD	V
Input logic level high	VIH	0.75VDD		VDD+0.3	V
Output logic level low	VOL	N		0.1VDD	V
Output logic level high	VOH	0.8VDD		N	V

Note: Test conditions: VDD = 3.3V, Temperature = 20  $^{\circ}$ C, if nothing special is stated.

### 5. RF Performance

**Table 10 RF Performance** 

Description	Min	Тур.	Max	Unit
Input frequency	2400		2483.5	MHz
Input impedance		50		ohm
Input impedance			-10	dB

Output power of PA for 72.2Mbps	15.5	16.5	17.5	dBm
Output power of PA for 11b mode	19.5	20.5	21.5	dBm
Sensitivity				
CCK, 1 Mbps		-98		dBm
CCK, 11 Mbps		-91		dBm
6 Mbps (1/2 BPSK)		-93		dBm
54 Mbps (3/4 64-QAM)		-75		dBm
HT20, MCS7 (65 Mbps, 72.2 Mbps)		-72		dBm
Adjacent Channel Rejection				
OFDM, 6 Mbps		37		dB
OFDM, 54 Mbps		21		dB
HT20, MCS0		37		dB
HT20, MCS7		20		dB

# 6. Power Consumption

**Table 11 Power Consumption** 

Parameters	Min	Typical	Max	Unit
Tx802.11b, CCK 11Mbps, P OUT=+17dBm		170		mA
Tx 802.11g, OFDM 54Mbps, P OUT =+15dBm		140		mA
Tx 802.11n, MCS7, P OUT =+13dBm		120		mA
Rx 802.11b, 1024 bytes packet length , -80dBm		50		mA
Rx 802.11g, 1024 bytes packet length, -70dBm		56		mA
Rx 802.11n, 1024 bytes packet length, -65dBm		56		mA
Modem-Sleep①		15		mA
Light-Sleep②		0.9		mA
Deep-Sleep③		10		uA
Power Off		0.5		uA

1 Modem-Sleep requires the CPU to be working, as in PWM or I2S applications. According to 802.11 standards (like U-APSD), it saves power to shut down the Wi-Fi Modem circuit while maintaining a Wi-Fi connection with no data transmission. E.g. in DTIM3, to maintain a sleep 300mswake 3ms cycle to receive AP's Beacon packages, the current is about 15mA.

2 During Light-Sleep, the CPU may be suspended in applications like Wi-Fi switch. Without data transmission, the Wi-Fi Modem circuit can be turned off and CPU suspended to save power according to the 802.11 standard (U-APSD). E.g. in DTIM3, to maintain a sleep 300ms-wake 3ms cycle to receive AP's Beacon packages, the current is about 0.9mA.

3 Deep-Sleep does not require Wi-Fi connection to be maintained. For application with long time lags between data transmission, e.g. a temperature sensor that checks the temperature every 100s, sleep 300s and waking up to connect to the AP (taking about 0.3~1s), the overall average current is less than 1mA.

# 7. Reflow Profile

### **Table 12 Instructions**

TS max to TL (Ramp-up Rate)	3 ℃/second max		
Preheat	150℃		
Temperature Min.(TS Min.)			
Temperature Typical.(TSTyp.)	175°C		
Temperature Min.(TS Max.)			
Time(TS)	200°C		
	60~180 seconds		
Ramp-up rate (TL to TP)	3 ℃/second max		
Time Maintained Above:	217 °C /60~150 seconds		
Temperature(TL)/Time(TL)	, i		
Peak Temperature(TP)	260 °C max. for 10 seconds		
Target Peak Temperature (TP Target)	260°C+0/-5°C		
Time within 5 $^{\circ}\mathrm{C}$ of actual peak(tP)	20~40 seconds		
TS max to TL (Ramp-down Rate)	6 ℃/second max		
Tune 25 $^{\circ}\!$	8 minutes max		
Turie 25 C to Peak Temperature (t)	o minutes max		

# 8. Schematics

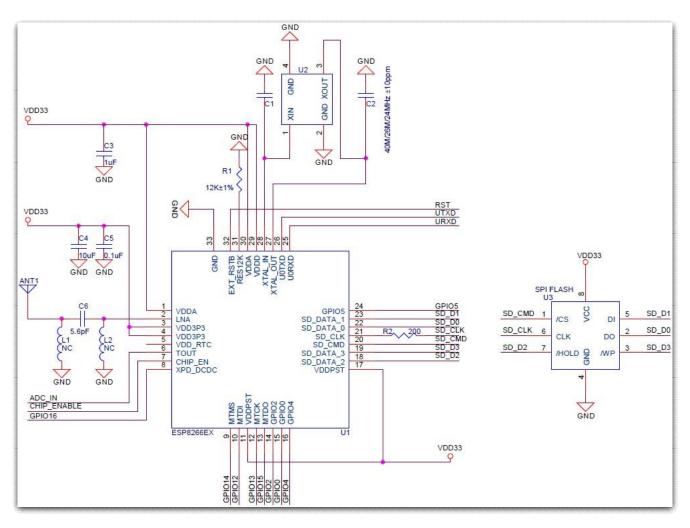


Figure 4 Schematics of ESP-07 WiFi Module